



VCSELS in LHCb

LHCb has 3068 installed, all the same device, driven by GOL

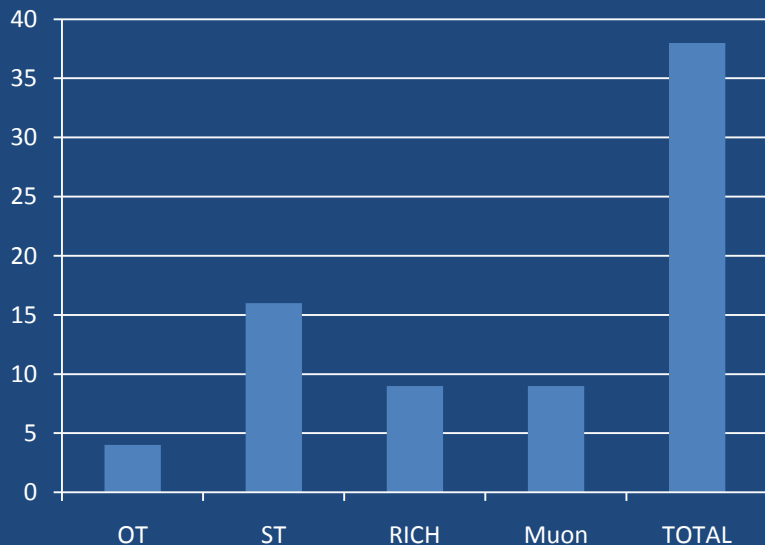
2000 in Silicon Tracker

432 in Outer Tracker

484 in RICH

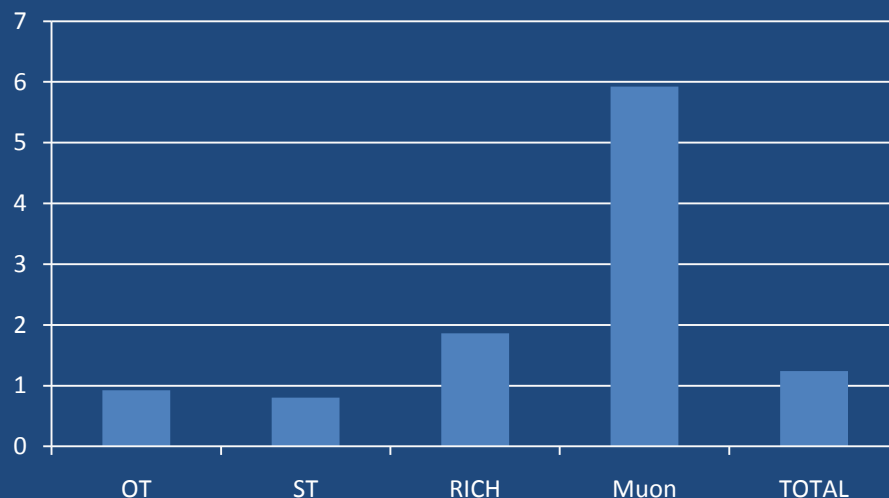
152 in Muons

Total VCSELS dead



Ken Wyllie, CERN

Percentage of sub-detector



Opto WG, TWEPP2010

VCSEL

Oxide-confined, 850nm, 6mW, 1mA threshold

Packaging (2 steps): TO-46
SMA



Burn-in after TO-46 packaging (48h at 100degC, 15mA)

Vendor promises:

good handling (ESD) procedures (but LHCb can't!)

good hermetic sealing

wafer position tracing (all from one wafer)

Bias currents 1.5 – 3 mA, modulation current = 10mA (fixed)

They are ALWAYS biased above threshold

Timeline

Before spring 2010:

RICH2 early deaths (2007-2008)

RICH1 (3): 2009(2), 2010(1)

All of Muon deaths

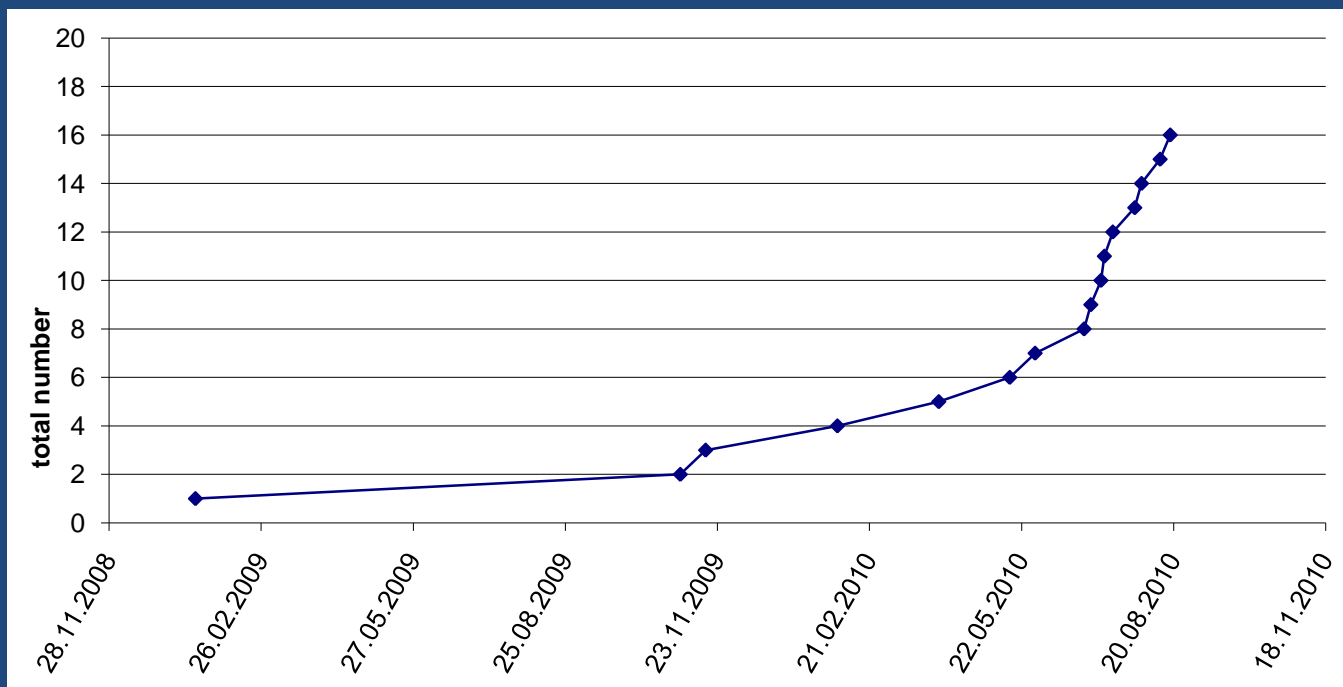
Since spring 2010:

All deaths in OT

Most in ST

RICH2 (2)

Rate is slow (or zero) except Silicon Tracker (biggest user)



RICH tests

After consultation from Stefan Simion (ATLAS LAr), we measured optical spectrum of ~ 150 VCSELs in RICH

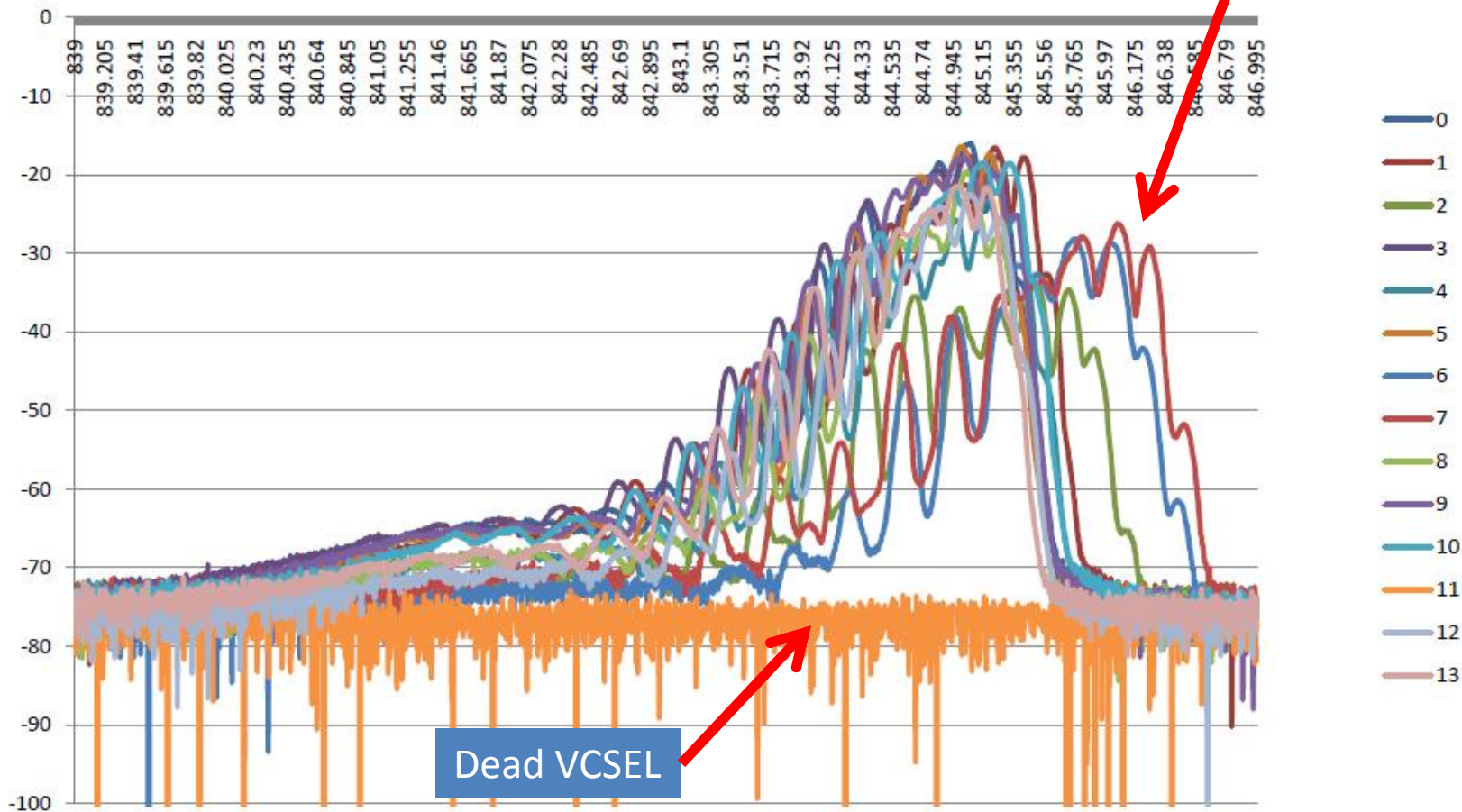
Look for correlation between spectrum shape and future death:

one subsequently died, but spectrum looked 'normal'

We would like to measure all VCSELs when data-taking stops this year

OSA on RICH1, column D3

Higher bias



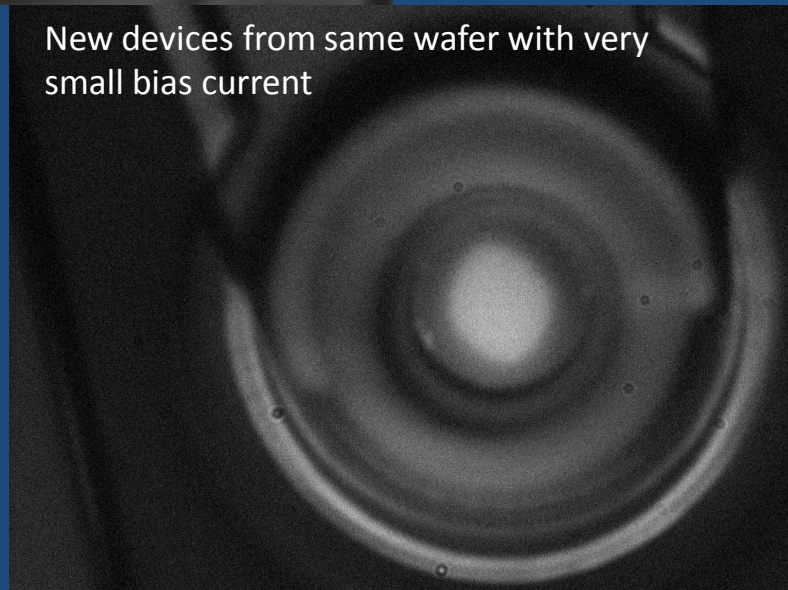
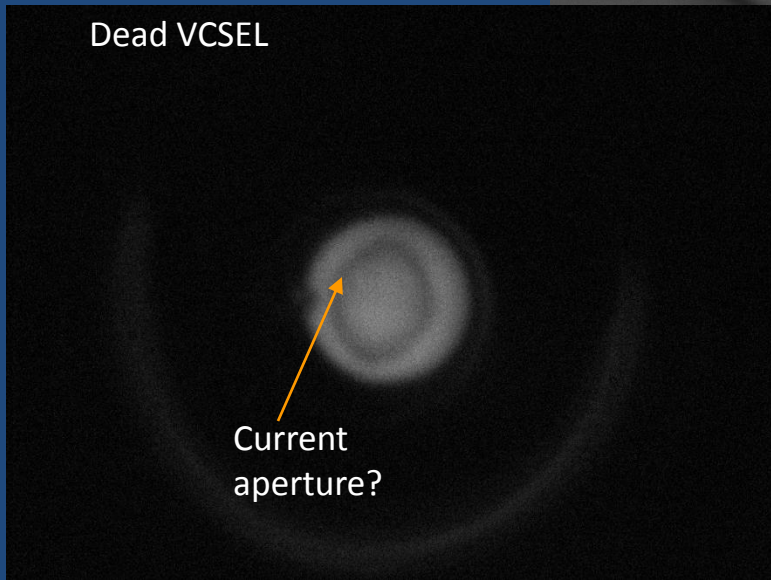
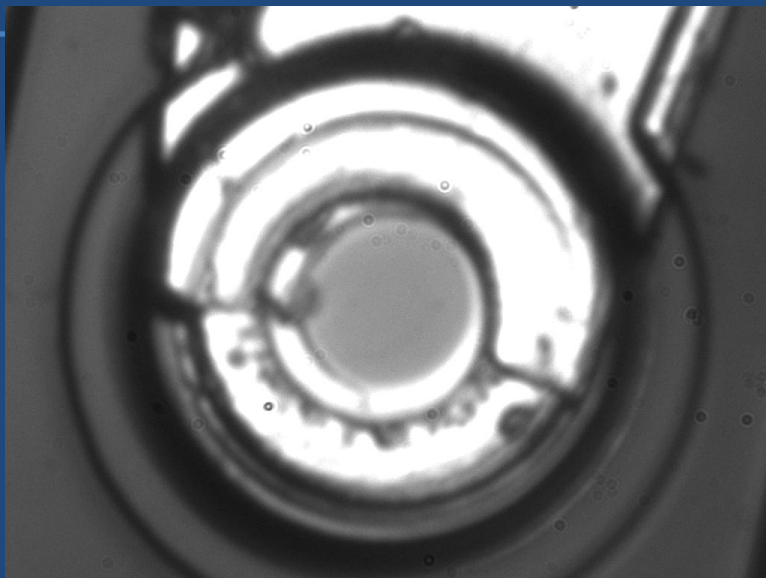
Failure analysis by vendor

LIV curves: downward shift in diode-turn-on voltage

Only light output from spontaneous emission
-> electro-luminescence images

Preparing for imaging with electron microscope (DLDs)

Vendor admits failure rate is much higher than normal



Plans

Discussing with vendor on:

Failure analysis

Bad wafer?

-> vendor will extend burn-in on samples from same wafer and another wafer

Purchase replacements (based on these results)

Consider alternative devices.....

End of year:

OSA measurements, and replace suspicious devices

Our VCSELS are 'accessible'